

EPROM Memory Programming Specification

This document includes the programming specifications for the following devices:

- PIC16C554
- PIC16C556
- PIC16C558

1.0 PROGRAMMING THE PIC16C55X

The PIC16C55X can be programmed using a serial method. In serial mode the PIC16C55X can be programmed while in the users system. This allows for increased design flexibility.

1.1 Hardware Requirements

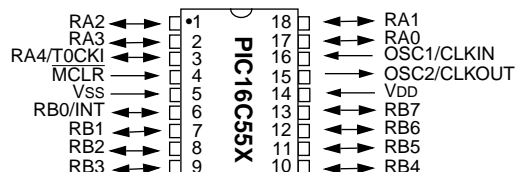
The PIC16C55X requires two programmable power supplies, one for VDD (2.0V to 6.5V recommended) and one for VPP (12V to 14V). Both supplies should have a minimum resolution of 0.25V.

1.2 Programming Mode

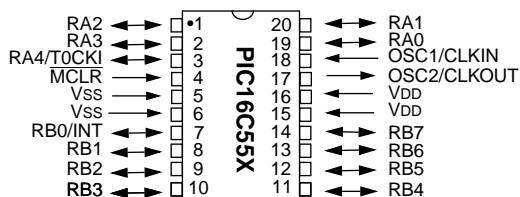
The programming mode for the PIC16C55X allows programming of user program memory, special locations used for ID, and the configuration word for the PIC16C55X.

Pin Diagrams

PDIP, SOIC, Windowed Cerdip



SSOP



Note: Peripheral pinout functions are not shown (see data sheets for full pinout information).

PIN DESCRIPTIONS (DURING PROGRAMMING): PIC16C554/556/558

Pin Name	During Programming		
	Pin Name	Pin Type	Pin Description
RB6	CLOCK	I	Clock input
RB7	DATA	I/O	Data input/output
MCLR/VPP	VPP	P	Programming Power
VDD	VDD	P	Power Supply
VSS	VSS	P	Ground

Legend: I = Input, O = Output, P = Power

2.0 PROGRAM MODE ENTRY

2.1 User Program Memory Map

The user memory space extends from 0x0000 to 0x1FFF (8K). Table 2-1 shows actual implementation of program memory in the PIC16C55X family.

TABLE 2-1: IMPLEMENTATION OF PROGRAM MEMORY IN THE PIC16C55X

Device	Program Memory Size	Access to Program Memory
PIC16C554	0x000 - 0x1FF (0.5K)	PC<8:0>
PIC16C556	0x000 - 0x3FF (1K)	PC<9:0>
PIC16C558	0x000 - 0x7FF (2K)	PC<10:0>

When the PC reaches the last location of the implemented program memory, it will wrap around and address a location within the physically implemented memory (see Figure 2-1).

In programming mode the program memory space extends from 0x0000 to 0x3FFF, with the first half (0x0000-0x1FFF) being user program memory and the second half (0x2000-0x3FFF) being configuration memory. The PC will increment from 0x0000 to 0x1FFF and wrap to 0x000 or 0x2000 to 0x3FFF and wrap around to 0x2000 (not to 0x0000). Once in configuration memory, the highest bit of the PC stays a '1', thus always pointing to the configuration memory. The only way to point to user program memory is to reset the part and reenter program/verify mode, as described in Section 2.2.

In the configuration memory space, 0x2000-0x20FF are utilized. When in a configuration memory, as in the user memory, the 0x2000-0x2XFF segment is repeatedly accessed as the PC exceeds 0x2XFF (see Figure 2-1).

A user may store identification information (ID) in four ID locations. The ID locations are mapped in [0x2000 : 0x2003]. It is recommended that the user use only the four least significant bits of each ID location. In some devices, the ID locations read-out in a scrambled fashion after code protection is enabled. For these devices, it is recommended that ID location is written as "11 1111 1000 bbbb" where 'bbbb' is ID information.

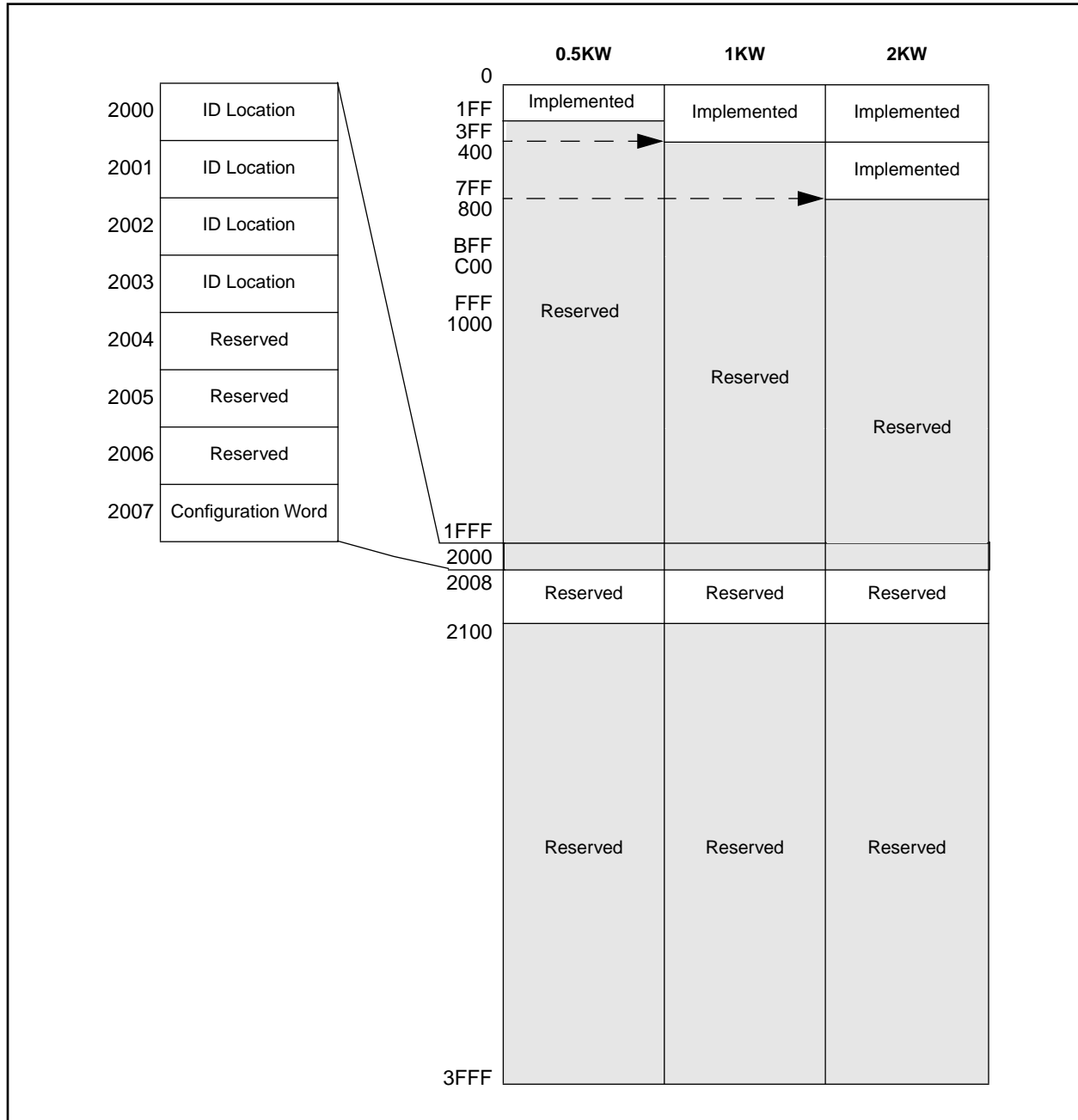
Note: All other locations are reserved and should not be programmed.

In other devices, the ID locations read out normally, even after code protection. To understand how the devices behave, refer to Table 4-1.

To understand the scrambling mechanism after code protection, refer to Section 4.1.

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FIGURE 2-1: PROGRAM MEMORY MAPPING



2.2 Program/Verify Mode

The program/verify mode is entered by holding pins RB6 and RB7 low while raising $\overline{\text{MCLR}}$ pin from V_{IL} to V_{IH} (high voltage). Once in this mode the user program memory and the configuration memory can be accessed and programmed in serial fashion. The mode of operation is serial, and the memory that is accessed is the user program memory. RB6 is a Schmitt Trigger input in this mode.

The sequence that enters the device into the programming/verify mode places all other logic into the reset state (the $\overline{\text{MCLR}}$ pin was initially at V_{IL}). This means that all I/O are in the reset state (High impedance inputs).

Note: The $\overline{\text{MCLR}}$ pin should be raised as quickly as possible from V_{IL} to V_{IH} . This is to ensure that the device does not have the PC incremented while in valid operation range.

2.2.1 PROGRAM/VERIFY OPERATION

The RB6 pin is used as a clock input pin, and the RB7 pin is used for entering command bits and data input/output during serial operation. To input a command, the clock pin (RB6) is cycled six times. Each command bit is latched on the falling edge of the clock with the least significant bit (LSB) of the command being input first. The data on pin RB7 is required to have a minimum setup and hold time (see AC/DC specs) with respect to the falling edge of the clock. Commands that have data associated with them (read

and load) are specified to have a minimum delay of $1\mu\text{s}$ between the command and the data. After this delay the clock pin is cycled 16 times with the first cycle being a start bit and the last cycle being a stop bit. Data is also input and output LSB first. Therefore, during a read operation the LSB will be transmitted onto pin RB7 on the rising edge of the second cycle, and during a load operation the LSB will be latched on the falling edge of the second cycle. A minimum $1\mu\text{s}$ delay is also specified between consecutive commands.

All commands are transmitted LSB first. Data words are also transmitted LSB first. The data is transmitted on the rising edge and latched on the falling edge of the clock. To allow for decoding of commands and reversal of data pin configuration, a time separation of at least $1\mu\text{s}$ is required between a command and a data word (or another command).

The commands that are available are listed in Table 2-2.

2.2.1.1 LOAD CONFIGURATION

After receiving this command, the program counter (PC) will be set to $0x2000$. By then applying 16 cycles to the clock pin, the chip will load 14-bits a "data word" as described above, to be programmed into the configuration memory. A description of the memory mapping schemes for normal operation and configuration mode operation is shown in Figure 2-1. After the configuration memory is entered, the only way to get back to the user program memory is to exit the program/verify test mode by taking $\overline{\text{MCLR}}$ low (V_{IL}).

TABLE 2-2: COMMAND MAPPING

Command	Mapping (MSB ... LSB)						Data
Load Configuration	0	0	0	0	0	0	0, data(14), 0
Load Data	0	0	0	0	1	0	0, data(14), 0
Read Data	0	0	0	1	0	0	0, data(14), 0
Increment Address	0	0	0	1	1	0	
Begin programming	0	0	1	0	0	0	
End Programming	0	0	1	1	1	0	

Note: The CPU clock must be disabled during in-circuit programming.

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FIGURE 2-2: PROGRAM FLOW CHART - PIC16C55X PROGRAM MEMORY

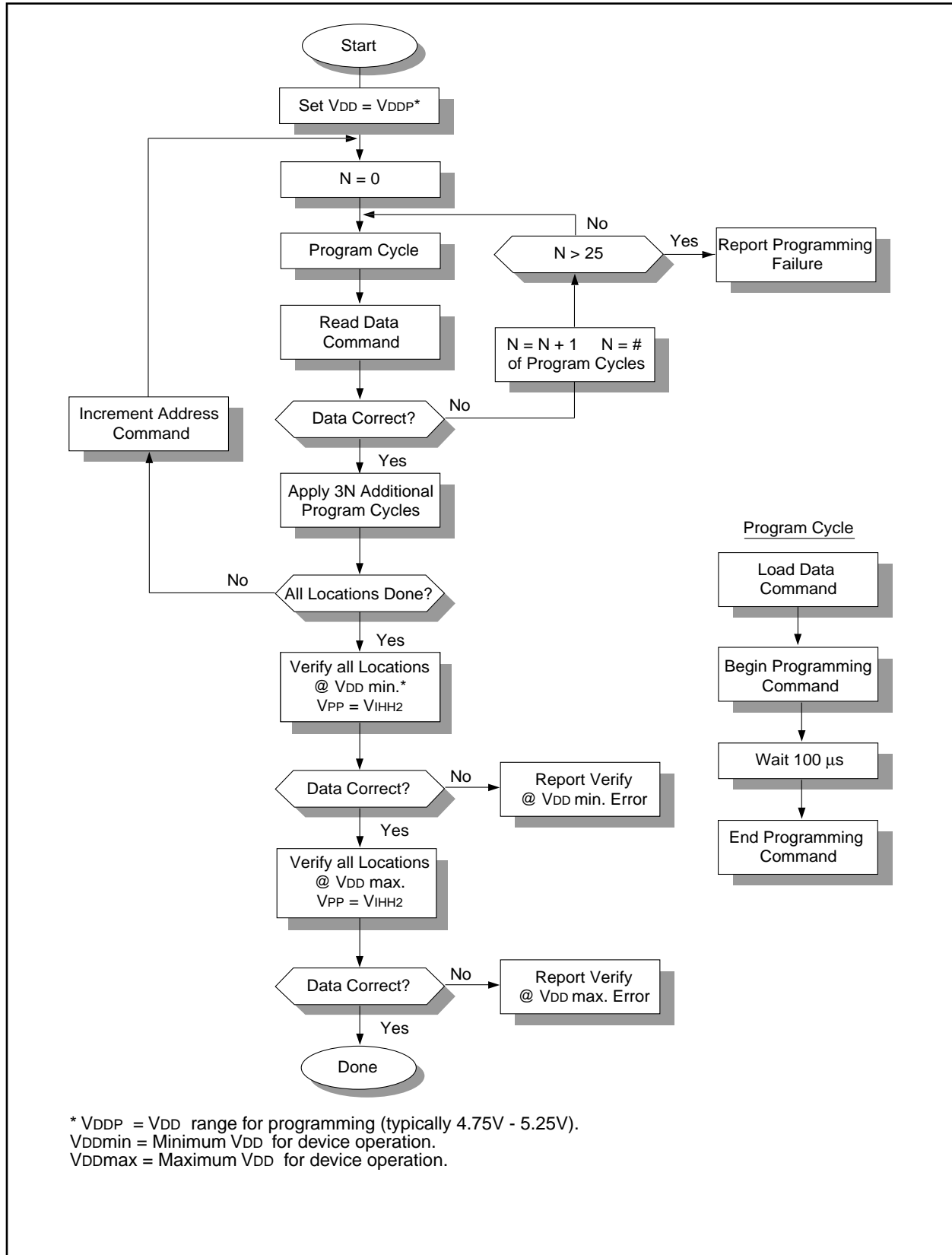
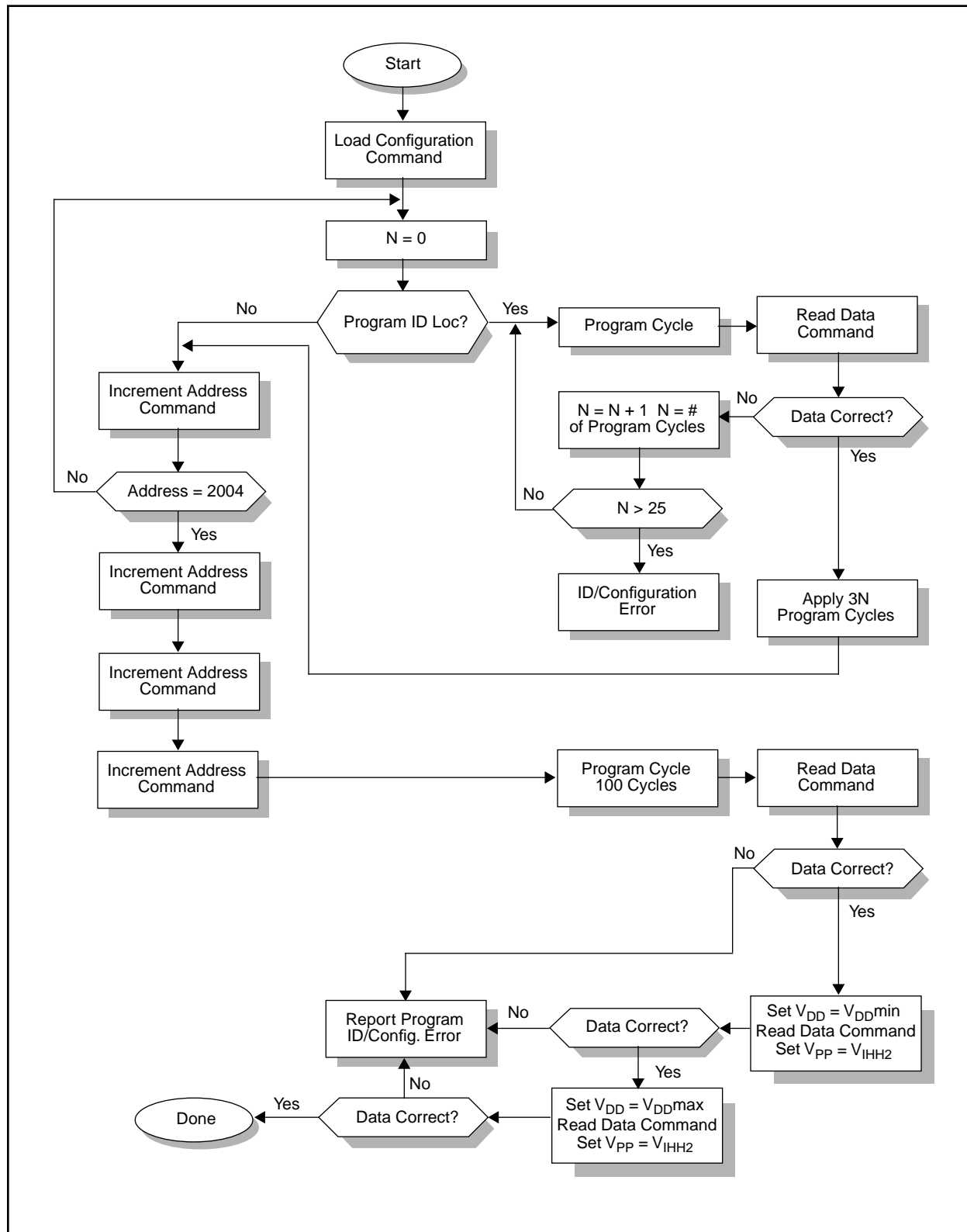


FIGURE 2-3: PROGRAM FLOW CHART - PIC16C55X CONFIGURATION WORD & ID LOCATIONS



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2.2.1.2 LOAD DATA

After receiving this command, the chip will load in a 14-bit "data word" when 16 cycles are applied, as described previously. A timing diagram for the load data command is shown in Figure 5-1.

2.2.1.3 READ DATA

After receiving this command, the chip will transmit data bits out of the memory currently accessed starting with the second rising edge of the clock input. The RB7 pin will go into output mode on the second rising clock edge, and it will revert back to input mode (hi-impedance) after the 16th rising edge. A timing diagram of this command is shown in Figure 5-2.

2.2.1.4 INCREMENT ADDRESS

The PC is incremented when this command is received. A timing diagram of this command is shown in Figure 5-3.

2.2.1.5 BEGIN PROGRAMMING

A load command (load configuration or load data) must be given before every begin programming command. Programming of the appropriate memory (test program memory or user program memory) will begin after this command is received and decoded. Programming should be performed with a series of 100 μ s programming pulses. A programming pulse is defined as the time between the begin programming command and the end programming command.

2.2.1.6 END PROGRAMMING

After receiving this command, the chip stops programming the memory (configuration program memory or user program memory) that it was programming at the time.

2.3 Programming Algorithm Requires Variable VDD

The PIC16C55X uses an intelligent algorithm. The algorithm calls for program verification at VDDmin as well as VDDmax. Verification at VDDmin guarantees good "erase margin". Verification at VDDmax guarantees good "program margin".

The actual programming must be done with VDD in the VDDP range (4.75 - 5.25V).

VDDP = VCC range required during programming.

VDD min. = minimum operating VDD spec for the part.

VDD max. = maximum operating VDD spec for the part.

Programmers must verify the PIC16C55X at its specified VDDmax and VDDmin levels. Since Microchip may introduce future versions of the PIC16C55X with a broader VDD range, it is best that these levels are user selectable (defaults are ok).

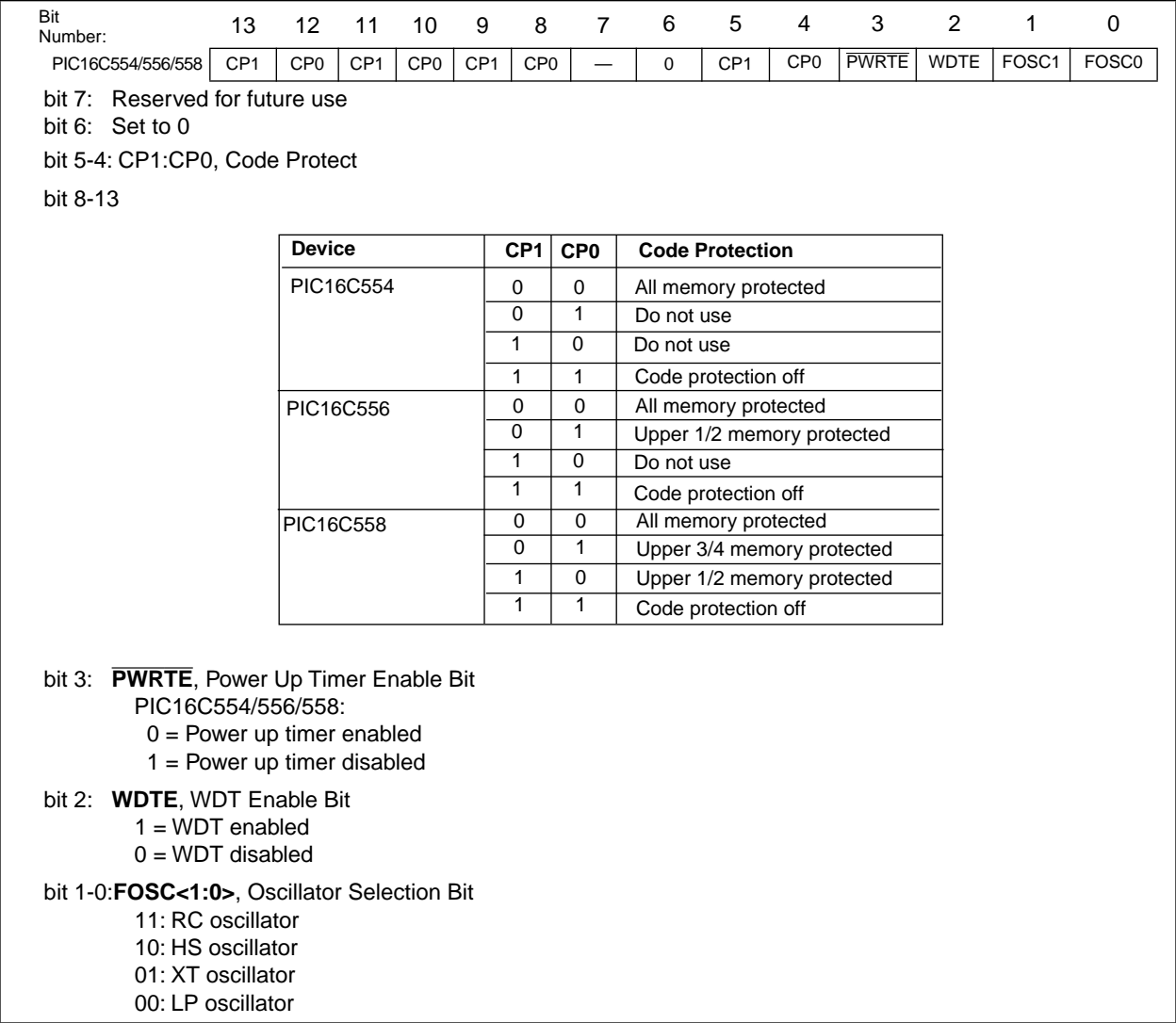
Note: Any programmer not meeting these requirements may only be classified as "prototype" or "development" programmer but not a "production" quality programmer.

PIC16C55X

3.0 CONFIGURATION WORD

The PIC16C55X family members have several configuration bits. These bits can be programmed (reads '0') or left unprogrammed (reads '1') to select various device configurations. Figure 3-1 provides an overview of configuration bits.

FIGURE 3-1: CONFIGURATION WORD BIT MAP



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4.0 CODE PROTECTION

The program code written into the EPROM can be protected by writing to the CP0 & CP1 bits of the configuration word.

4.1 Programming Locations 0x0000 to 0x03F after Code Protection

For PIC16C55X devices, once code protection is enabled, all protected segments read '0's (or "garbage values") and are prevented from further programming. All unprotected segments, including ID locations and configuration word, read normally. These locations can be programmed.

4.2 Embedding Configuration Word and ID Information in the Hex File

To allow portability of code, the programmer is required to read the configuration word and ID locations from the hex file when loading the hex file. If configuration word information was not present in the hex file then a simple warning message may be issued. Similarly, while saving a hex file, configuration word and ID information must be included. An option to not include this information may be provided.

Microchip Technology Inc. feels strongly that this feature is important for the benefit of the end customer.

TABLE 4-1: CONFIGURATION WORD

PIC16C554

To code protect:

- Protect all memory 0000001000XXXX
- No code protection 1111111011XXXX

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

PIC16C556

To code protect:

- Protect all memory 0000001000XXXX
- Protect upper 1/2 memory 0101011001XXXX
- No code protection 1111111011XXXX

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

PIC16C558

To code protect:

- Protect all memory 0000001000XXXX
- Protect upper 3/4 memory 0101011001XXXX
- Protect upper 1/2 memory 1010101010XXXX
- No code protection 1111111011XXXX

Program Memory Segment	R/W in Protected Mode	R/W in Unprotected Mode
Configuration Word (0x2007)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Unprotected memory segment	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled
Protected memory segment	Read All 0's, Write Disabled	Read Unscrambled, Write Enabled
ID Locations (0x2000 : 0x2003)	Read Unscrambled, Write Enabled	Read Unscrambled, Write Enabled

4.3 Checksum

4.3.1 CHECKSUM CALCULATIONS

Checksum is calculated by reading the contents of the PIC16C55X memory locations and adding up the opcodes up to the maximum user addressable location, e.g., 0x1FF for the PIC16C74. Any carry bits exceeding 16-bits are neglected. Finally, the configuration word (appropriately masked) is added to the checksum. Checksum computation for each member of the PIC16C55X devices is shown in Table 4-2.

The checksum is calculated by summing the following:

- The contents of all program memory locations
- The configuration word, appropriately masked
- Masked ID locations (when applicable)

The least significant 16 bits of this sum is the checksum.

The following table describes how to calculate the checksum for each device. Note that the checksum calculation differs depending on the code protect setting. Since the program memory locations read out differently depending on the code protect setting, the table describes how to manipulate the actual program memory values to simulate the values that would be read from a protected device. When calculating a checksum by reading a device, the entire program memory can simply be read and summed. The configuration word and ID locations can always be read.

Note that some older devices have an additional value added in the checksum. This is to maintain compatibility with older device programmer checksums.

TABLE 4-2: CHECKSUM COMPUTATION

Device	Code Protect	Checksum*	Blank Value	0x25E6 at 0 and max address
PIC16C554	OFF ALL	SUM[0x000:0x1FF] + CFGW & 0x3F7F SUM_ID + CFGW & 0x3F7F	3D7F 3DCE	094D 099C
PIC16C556	OFF 1/2 ALL	SUM[0x000:0x3FF] + CFGW & 0x3F7F SUM[0x000:0x1FF] + CFGW & 0x3F7F + SUM_ID CFGW & 0x3F7F + SUM_ID	3B7F 4EDE 3BCE	074D 0093 079C
PIC16C558	OFF 1/2 3/4 ALL	SUM[0x000:0x7FF] + CFGW & 0x3F7F SUM[0x000:0x3FF] + CFGW & 0x3F7F + SUM_ID SUM[0x000:0x1FF] + CFGW & 0x3F7F + SUM_ID CFGW & 0x3F7F + SUM_ID	377F 5DEE 4ADE 37CE	034D 0FA3 FC93 039C

Legend: CFGW = Configuration Word

SUM[a:b] = [Sum of locations a through b inclusive]

SUM_ID = ID locations masked by 0xF then made into a 16-bit value with ID0 as the most significant nibble.

For example,

ID0 = 0x12, ID1 = 0x37, ID2 = 0x4, ID3 = 0x26, then SUM_ID = 0x2746.

*Checksum = [Sum of all the individual expressions] **MODULO** [0xFFFF]

+ = Addition

& = Bitwise AND

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5.0 PROGRAM/VERIFY MODE ELECTRICAL CHARACTERISTICS

TABLE 5-1: AC/DC CHARACTERISTICS
TIMING REQUIREMENTS FOR PROGRAM/VERIFY TEST MODE

Standard Operating Conditions							
Operating Temperature: $+10^{\circ}\text{C} \leq T_A \leq +40^{\circ}\text{C}$, unless otherwise stated, (25°C is recommended)							
Operating Voltage: $4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$, unless otherwise stated.							
Parameter No.	Sym.	Characteristic	Min.	Typ.	Max.	Units	Conditions
General							
PD1	VDDP	Supply voltage during programming	4.75	5.0	5.25	V	
PD2	IDDP	Supply current (from VDD) during programming			20	mA	
PD3	VDDV	Supply voltage during verify	VDDmin		VDDmax	V	Note 1
PD4	VIHH1	Voltage on MCLR/VPP during programming	12.75		13.25	V	Note 2
PD5	VIHH2	Voltage on MCLR/VPP during verify	VDD + 4.0		13.5		
PD6	I _{PP}	Programming supply current (from VPP)			50	mA	
PD9	VIH1	(RB6, RB7) input high level	0.8 VDD			V	Schmitt Trigger input
PD8	VIL1	(RB6, RB7) input low level	0.2 VDD			V	Schmitt Trigger input

Serial Program Verify							
P1	T _R	MCLR/VPP rise time (VSS to VHH) for test mode entry			8.0	μs	
P2	T _f	MCLR Fall time			8.0	μs	
P3	T _{set1}	Data in setup time before clock ↓	100			ns	
P4	T _{hld1}	Data in hold time after clock ↓	100			ns	
P5	T _{dly1}	Data input not driven to next clock input (delay required between command/data or command/command)	1.0			μs	
P6	T _{dly2}	Delay between clock ↓ to clock ↑ of next command or data	1.0			μs	
P7	T _{dly3}	Clock ↑ to data out valid (during read data)	200			ns	
P8	T _{hld0}	Hold time after MCLR ↑	2			μs	

Note 1: Program must be verified at the minimum and maximum VDD limits for the part.

Note 2: VIHH must be greater than VDD + 4.5V to stay in programming/verify mode.

FIGURE 5-1: LOAD DATA COMMAND (PROGRAM/VERIFY)

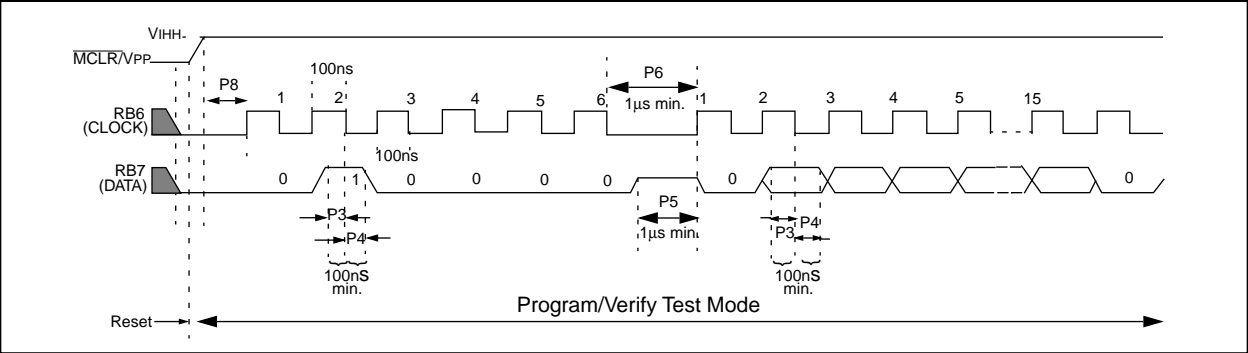


FIGURE 5-2: READ DATA COMMAND (PROGRAM/VERIFY)

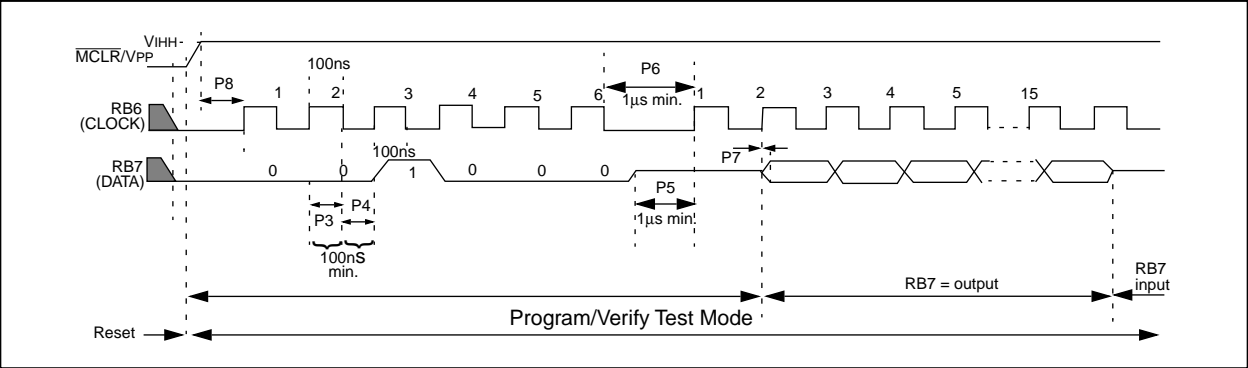
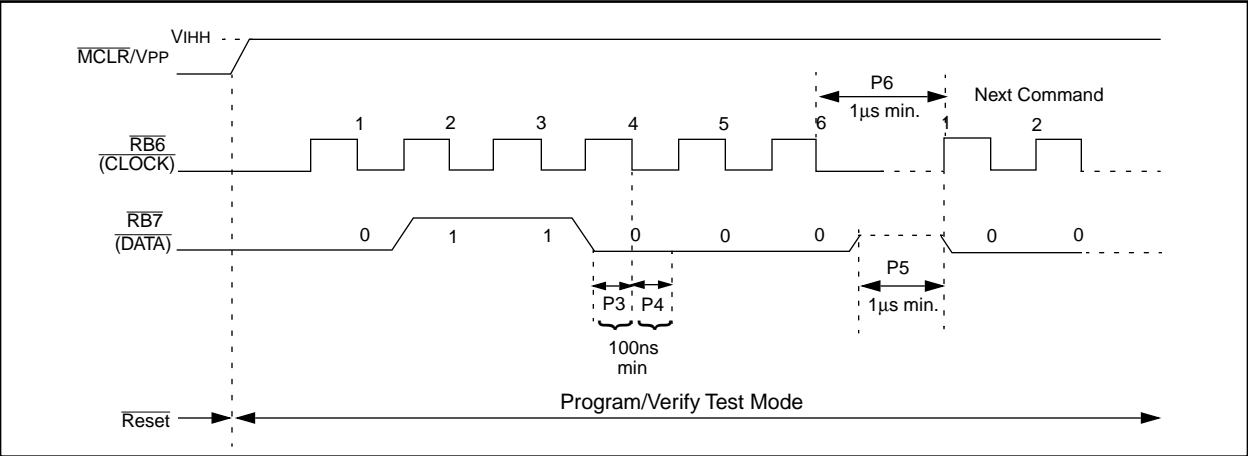


FIGURE 5-3: INCREMENT ADDRESS COMMAND (PROGRAM/VERIFY)



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Corporate Office

Microchip Technology Inc.
2355 West Chandler Blvd.
Chandler, AZ 85224-6199
Tel: 602-786-7200 Fax: 602-786-7277
Technical Support: 602 786-7627
Web: <http://www.microchip.com>

Atlanta

Microchip Technology Inc.
500 Sugar Mill Road, Suite 200B
Atlanta, GA 30350
Tel: 770-640-0034 Fax: 770-640-0307

Boston

Microchip Technology Inc.
5 Mount Royal Avenue
Marlborough, MA 01752
Tel: 508-480-9990 Fax: 508-480-8575

Chicago

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333 Pierce Road, Suite 180
Itasca, IL 60143
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Microchip Technology Inc.
14651 Dallas Parkway, Suite 816
Dallas, TX 75240-8809
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Dayton

Microchip Technology Inc.
Two Prestige Place, Suite 150
Miamisburg, OH 45342
Tel: 937-291-1654 Fax: 937-291-9175

Los Angeles

Microchip Technology Inc.
18201 Von Karman, Suite 1090
Irvine, CA 92612
Tel: 714-263-1888 Fax: 714-263-1338

New York

Microchip Technology Inc.
150 Motor Parkway, Suite 202
Hauppauge, NY 11788
Tel: 516-273-5305 Fax: 516-273-5335

San Jose

Microchip Technology Inc.
2107 North First Street, Suite 590
San Jose, CA 95131
Tel: 408-436-7950 Fax: 408-436-7955

Toronto

Microchip Technology Inc.
5925 Airport Road, Suite 200
Mississauga, Ontario L4V 1W1, Canada
Tel: 905-405-6279 Fax: 905-405-6253

ASIA/PACIFIC

Hong Kong

Microchip Asia Pacific
RM 3801B, Tower Two
Metroplaza
223 Hing Fong Road
Kwai Fong, N.T., Hong Kong
Tel: 852-2-401-1200 Fax: 852-2-401-3431

India

Microchip Technology Inc.
India Liaison Office
No. 6, Legacy, Convent Road
Bangalore 560 025, India
Tel: 91-80-229-0061 Fax: 91-80-229-0062

Japan

Microchip Technology Intl. Inc.
Benex S-1 6F
3-18-20, Shinyokohama
Kohoku-Ku, Yokohama-shi
Kanagawa 222 Japan
Tel: 81-45-471-6166 Fax: 81-45-471-6122

Korea

Microchip Technology Korea
168-1, Youngbo Bldg. 3 Floor
Samsung-Dong, Kangnam-Ku
Seoul, Korea
Tel: 82-2-554-7200 Fax: 82-2-558-5934

Shanghai

Microchip Technology
RM 406 Shanghai Golden Bridge Bldg.
2077 Yan'an Road West, Hong Qiao District
Shanghai, PRC 200335
Tel: 86-21-6275-5700
Fax: 86 21-6275-5060

Singapore

Microchip Technology Taiwan
Singapore Branch
200 Middle Road
#07-02 Prime Centre
Singapore 188980
Tel: 65-334-8870 Fax: 65-334-8850

ASIA/PACIFIC (CONTINUED)

Taiwan, R.O.C

Microchip Technology Taiwan
10F-1C 207
Tung Hua North Road
Taipei, Taiwan, ROC
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

EUROPE

United Kingdom

Arizona Microchip Technology Ltd.
505 Eskdale Road
Winnersh Triangle
Wokingham
Berkshire, England RG41 5TU
Tel: 44-1189-21-5858 Fax: 44-1189-21-5835

France

Arizona Microchip Technology SARL
Zone Industrielle de la Bonde
2 Rue du Buisson aux Fraises
91300 Massy, France
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany

Arizona Microchip Technology GmbH
Gustav-Heinemann-Ring 125
D-81739 München, Germany
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

Italy

Arizona Microchip Technology SRL
Centro Direzionale Colleoni
Palazzo Taurus 1 V. Le Colleoni 1
20041 Agrate Brianza
Milan, Italy
Tel: 39-39-6899939 Fax: 39-39-6899883

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